ANALOG Product/Process Change Notice - PCN 18_0209 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

PCN Title:	ADG419-EP Re-design with Wafer Fabrication Transfer		
Publication Date:	07-Jan-2019		
Effectivity Date:	11-Apr-2019	(the earliest date that a customer could expect to receive changed material)	
Revision Description:			

Initial Release

Description Of Change:

All layer re-design and transfer of the ADG419-EP from the 4" high voltage CMOS switch wafer fabrication process in Analog Devices Limerick Ireland to the equivalent 8" wafer fab process at the same location.

Reason For Change:

Increased wafer fabrication capacity.

Impact of the change (positive or negative) on fit, form, function & reliability:

This redesign and transfer will not affect the form, fit, function, quality or reliability of the ADG419-EP part.

Product Identification (this section will describe how to identify the changed material)

The new material change over date code will be advised in a later revision of this PCN.

Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results Summary.

Supporting Documents

Attachment 1: Type: Qualification Results Summary

ADI_PCN_18_0209_Rev_-_Qual_Results_Summary_ADG419EP.PDF

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.						
Americas:	Europe:	Japan:	Rest of Asia:			
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_ROA@analog.com			

Appendix A - Affected ADI Models					
Added Parts On This Revision - Product Family / Model Number (1)					
ADG419/ADG419SRMZ-EP-RL7					

Appendix B - Revision History				
Rev	Publish Date	Effectivity Date	Rev Description	
Rev	07-Jan-2019	11-Apr-2019	Initial Release	

Analog Devices, Inc.

Docld:4588 Parent Docld:None Layout Rev:7